



Infineon Technologies Key Facts

Headquarters:	Munich, Germany
Regional activities:	Americas: San Jose, California Asia Pacific: Singapore Japan: Tokyo
Fiscal year 2003 revenues: (ending September 2003)	Euro 6.15 billion
Employees: (ending September 2003)	About 32,300 worldwide, including 5,900 employees engaged in research and development
Market position 2003:	World's seventh-largest semiconductor manufacturer with a market share of 4 percent (according to iSuppli; status: 03/2004)
Main areas of activity:	Secure Mobile Solutions (No. 1 in chip card segment, leading Bluetooth market position, among the top 3 suppliers for GSM ICs) Wireline Communications (No. 1 in access market, especially in the ISDN and VDSL segment) Automotive and Industrial electronics (No. 2 in automotive segment worldwide; No. 1 in Europe) Memory Products (leading in 300-millimeter technology, No. 3 in DRAM products)

Manufacturing:	23 production sites (frontend and backend fabs) including state-of-the-art DRAM manufacturing on three continents (Europe, USA, Asia)
Research & Development:	45 market and customer-oriented development sites in 17 countries
R&D expenditures:	About Euro 1 billion (18 percent of total revenues in fiscal year 2003)
Strategic partnerships:	Nanya (technology development and production joint venture Inotera Memories in Taiwan) Winbond and SMIC in Taiwan and China (technology licensing and purchasing agreement) Infineon Technologies Suzhou Co., Ltd (assembly and testing joint venture in China) Saifun (Joint venture for Flash memories in Germany) IBM (technology development, joint manufacturing in France) AMD and DuPont Photomasks (joint venture for the development and production of next-generation lithographic photomasks) UMC (technology development for building logic chips)
Ticker symbol:	IFX; the company is listed on the DAX index of the Frankfurt Stock Exchange and on the New York Stock Exchange

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